

### ■ Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 °C to 100 °C
- REACH Compliance
- Halogen free
- MSL class 1

### ■ Applications

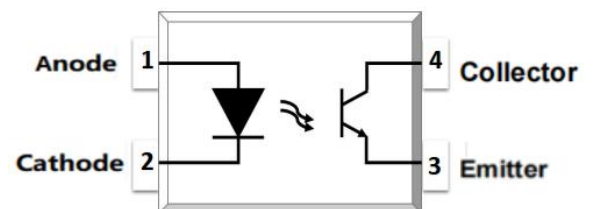
- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment

### ■ Description

The MP3H7 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SSOP4 package with different lead forming options.

With the robust coplanar double mold structure, MP3H7 series provide the most stable isolation feature.

### ■ Schematic





**MP3H7 Series**  
**SSOP4, DC Input, Photo Transistor Coupler**

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	VALUE	UNIT	NOTE
INPUT				
Forward Current	$I_F$	60	mA	
Peak Forward Current	$I_{FP}$	1	A	1
Reverse Voltage	$V_R$	6	V	
Input Power Dissipation	$P_I$	100	mW	
OUTPUT				
Collector - Emitter Voltage	$V_{CEO}$	80	V	
Emitter - Collector Voltage	$V_{ECO}$	7	V	
Collector Current	$I_C$	50	mA	
Output Power Dissipation	$P_O$	150	mW	
COMMON				
Total Power Dissipation	$P_{tot}$	200	mW	
Isolation Voltage	$V_{iso}$	3750	V <sub>rms</sub>	2
Operating Temperature	$T_{opr}$	-55~110	°C	
Storage Temperature	$T_{stg}$	-55~125	°C	
Soldering Temperature	$T_{sol}$	260	°C	

Note 1. 100 $\mu$ s pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. = 40 ~ 60%



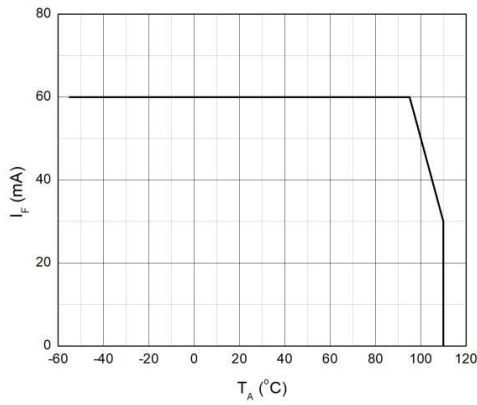
**MP3H7 Series**  
**SSOP4, DC Input, Photo Transistor Coupler**

ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C							
PARAMETER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT							
Forward Voltage	V <sub>F</sub>	-	-	1.4	V	IF=10mA	
Reverse Current	I <sub>R</sub>	-	-	10	μA	VR=6V	
Input Capacitance	C <sub>in</sub>	-	10	-	pF	V=0, f=1kHz	
OUTPUT							
Collector Dark Current	I <sub>CEO</sub>	-	-	100	nA	VCE=20V, IF=0	
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	80	-	-	V	IC=0.1mA, IF=0	
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	7	-	-	V	IE=0.1mA, IF=0	
TRANSFER CHARACTERISTICS							
Current Transfer Ratio	MP3H7	CTR	50	-	600	%	IF=5mA, VCE=5V
	MP3H7A		80	-	160		
	MP3H7B		130	-	260		
	MP3H7C		200	-	400		
	MP3H7D		300	-	600		
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	-	0.1	0.2	V	IF=10mA, IC=1mA	
Isolation Resistance	R <sub>ISO</sub>	10 <sup>12</sup>	10 <sup>14</sup>	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance	C <sub>IO</sub>	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)	t <sub>r</sub>	-	3	18	μs	VCE=2V, IC=2mA	3
Response Time (Fall)	t <sub>f</sub>	-	4	18	μs	RL=100Ω	3
Cut-off Frequency	f <sub>c</sub>	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω, -3dB	4

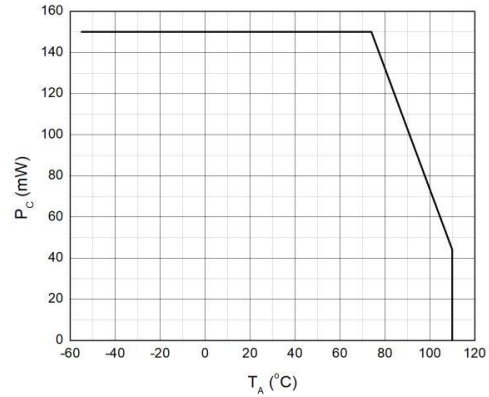
Note 3. Fig.12&13

Note 4. Fig.14

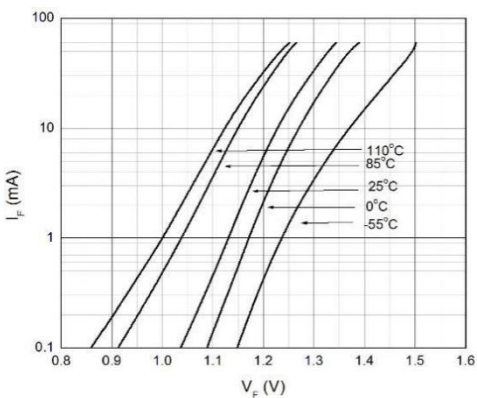
**CHARACTERISTIC CURVES**



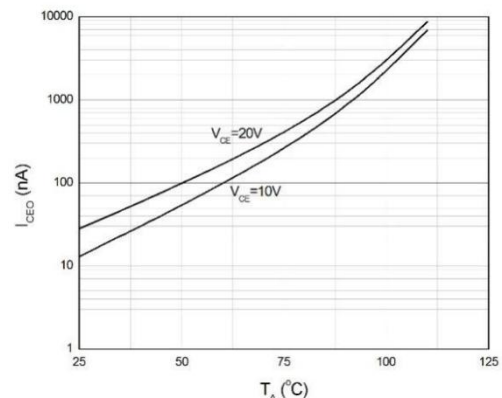
**Fig.1 Forward Current vs. Ambient Temperature**



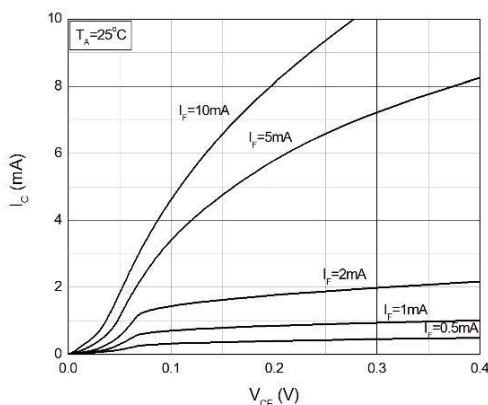
**Fig.2 Collector Power Dissipation vs. Ambient Temperature**



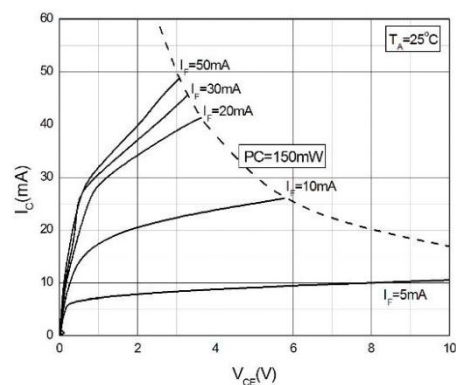
**Fig.3 Forward Current vs. Forward Voltage**



**Fig.4 Collector Dark Current vs. Ambient Temperature**

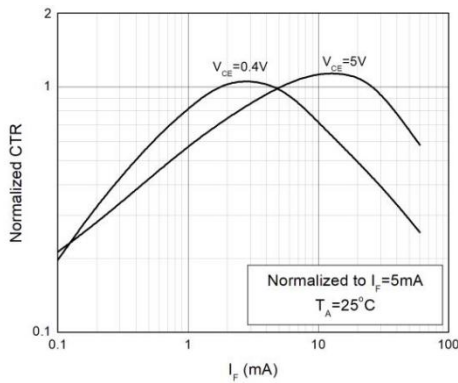


**Fig.5 Collector Current vs. Collector-emitter Voltage**

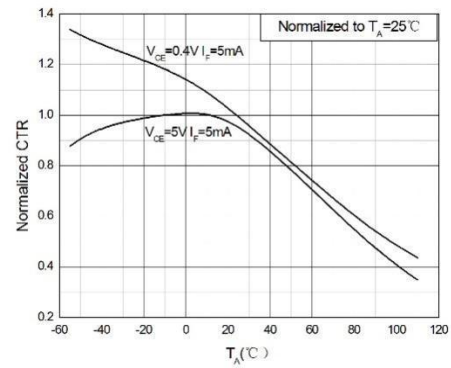


**Fig.6 Collector Current vs. Collector-emitter Voltage**

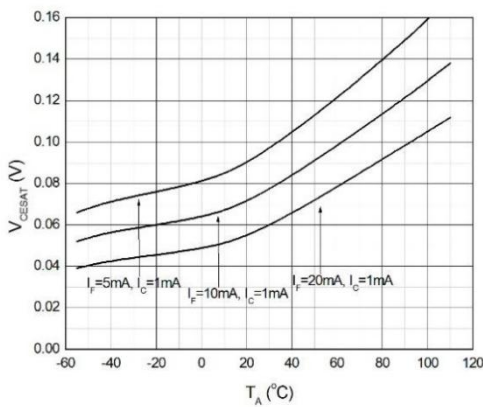
**CHARACTERISTIC CURVES**



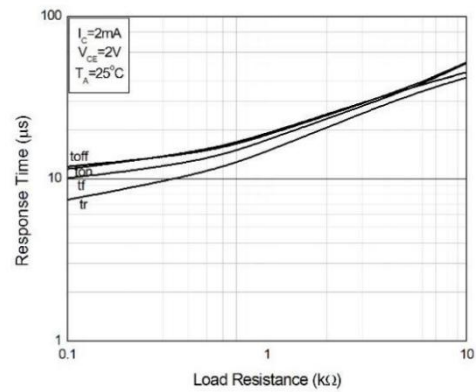
**Fig.7 Normalized Current Transfer Ratio vs. Forward Current**



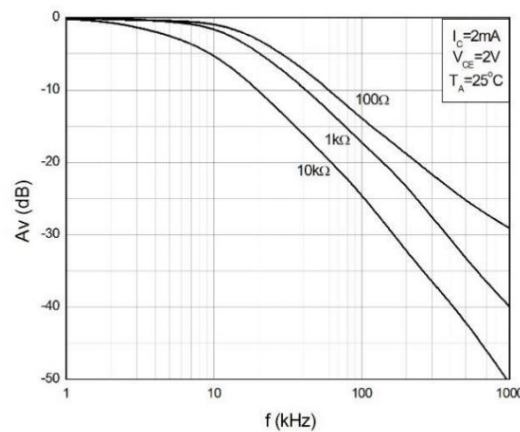
**Fig.8 Normalized Current Transfer Ratio vs. Ambient Temperature**



**Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature**

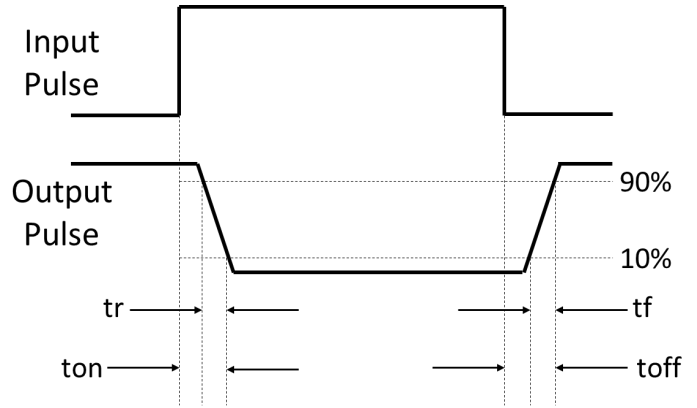
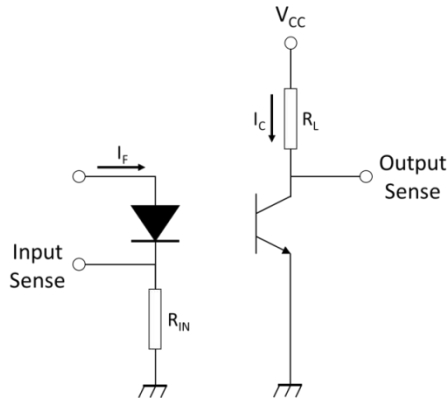


**Fig.10 Switching Time vs. Load Resistance**



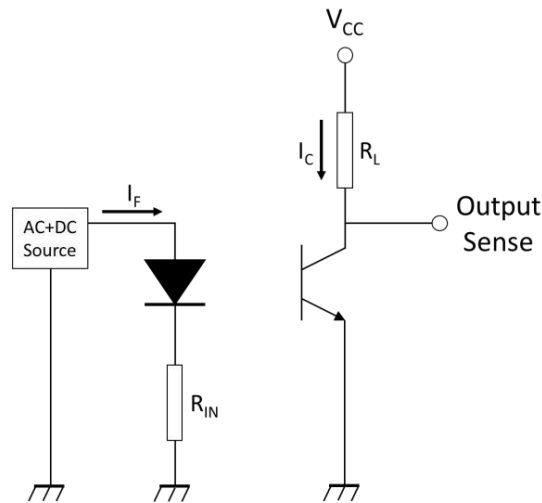
**Fig.11 Frequency Respons**

**TEST CIRCUITS**



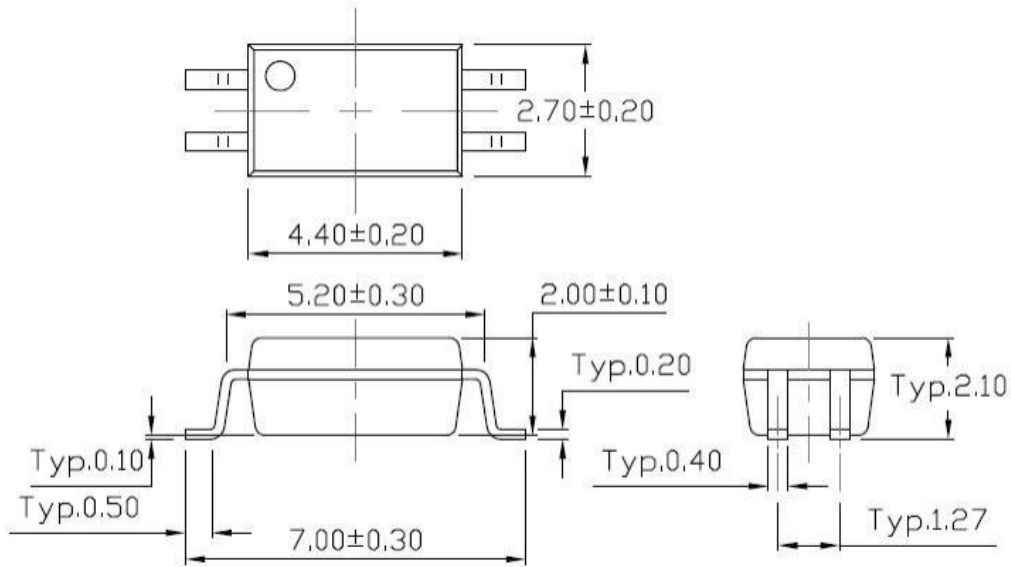
**Fig.12 Test Circuits of Response Time**

**Fig.13 Curves of Response Time**

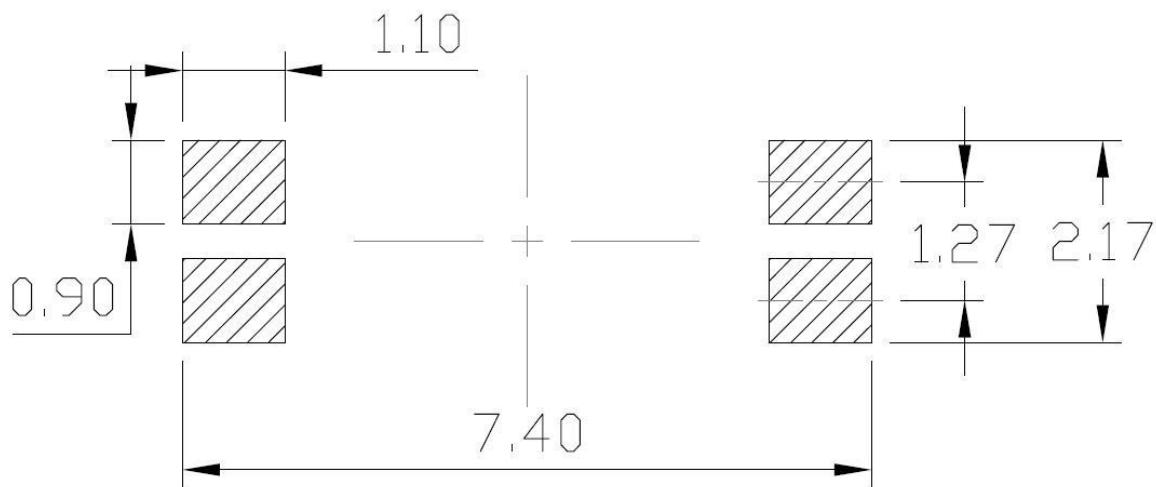


**Fig.14 Test Circuits of Frequency Response**

**PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)**

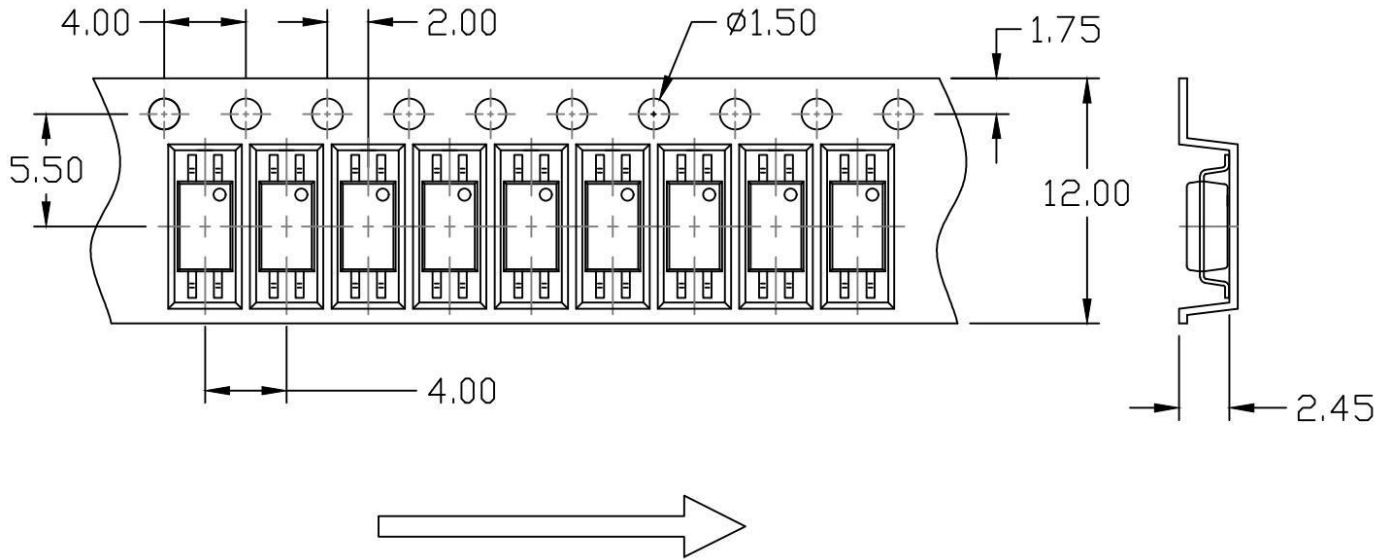


**Recommended Solder Mask (Dimensions in mm unless otherwise stated)**

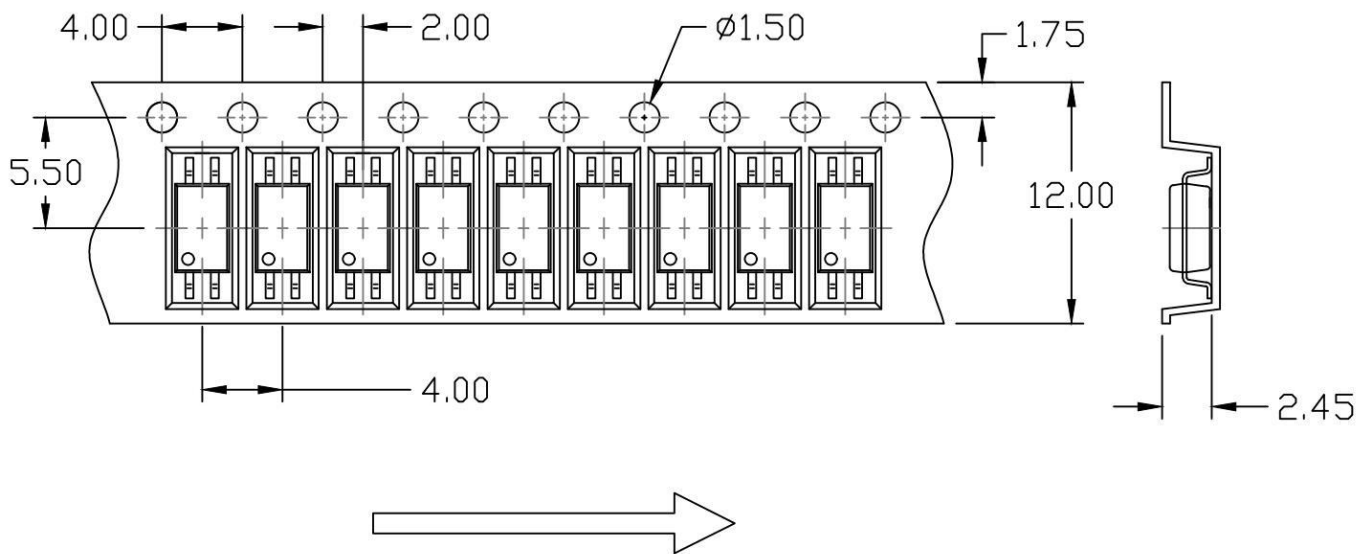


**CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)**

**Option T1**



**Option T2**

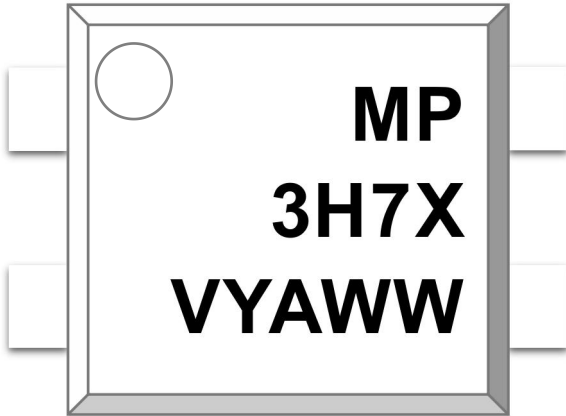






**ORDERING AND MARKING INFORMATION**

**MARKING INFORMATION**



**MP** :Company Abbr.  
**3H7** :Part Number  
**X** :CTR Rank  
**V** :VDE Option  
**Y** :Fiscal Year  
**A** :Manufacturing Code  
**WW** :Work Week

**ORDERING INFORMATION**

**MP3H7X(Z)-GV**

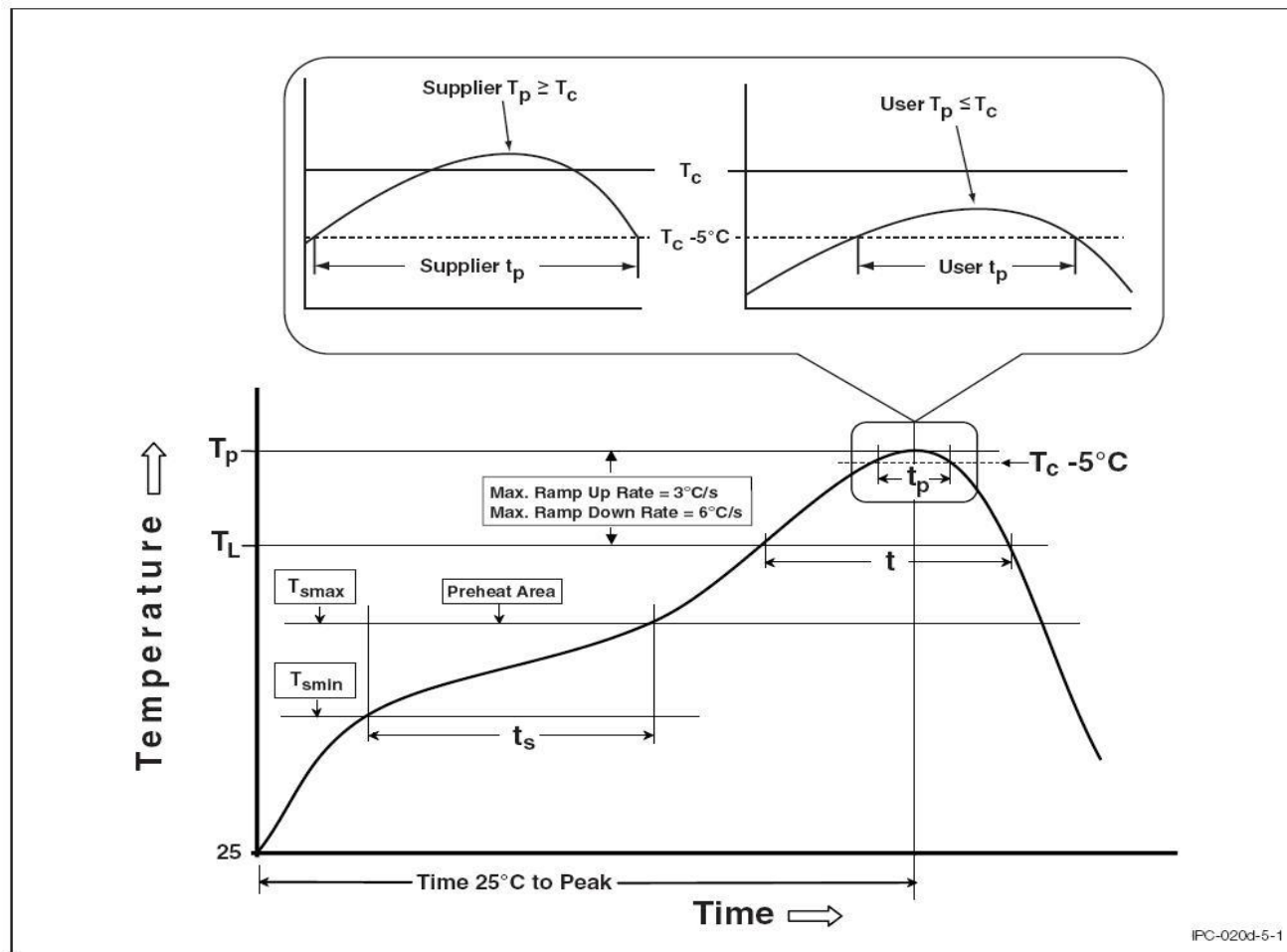
MP – Company Abbr.  
 3H7 – Part Number  
 X – Rank (A/B or None)  
 Z – Tape and Reel Option (T1/T2)  
 G – Material Option (G: Green, None: Non-Green)  
 V – VDE Option (V or None)

**PACKING QUANTITY**

Option	Quantity	Quantity – Inner box	Quantity – Outer box
T1	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units
T2	3000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 45k Units

**REFLOW INFORMATION**

**REFLOW PROFILE**



IPC-020d-5-1

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T <sub>smin</sub> )	100	150°C
Temperature Max. (T <sub>smax</sub> )	150	200°C
Time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds	60-120 seconds
Ramp-up Rate (t <sub>L</sub> to t <sub>p</sub> )	3°C/second max.	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (t <sub>p</sub> ) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T <sub>p</sub> to T <sub>L</sub> )	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



**DISCLAIMER**

- Our company is continually improving the quality, reliability, function and design. Our company reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Immerge unit's body in solder paste is not recommended.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.

■ **Revision History**

<b>Version</b>	<b>Date</b>	<b>Subjects (major changes since last revision)</b>
0.1	2023-07-05	Datasheet Complete
0.2	2023-08-09	Datasheet Upgrade